

EXTENDED TEMPERATURE MID-BOARD OPTICAL SYSTEM

FIREFLY™ MICRO FLYOVER SYSTEM™

Small footprint to increase density close to the IC

- Extended temperature range from -40 °C to +85 °C for military, aerospace and industrial applications
- High-speed performance to 10.3125 Gbps per channel (x4 & x12) and 25.7 Gbps (x4 only)
- x12 and x4 transceiver system
- Demonstrated error-free transmission during applied external vibrations and shock test, to methods specified in MIL-STD-810
- Data connection is taken "off board," simplifying board layout and enhancing signal integrity
- Integral heat sink provides optimal cooling for thermal operating conditions
- High-density solution with an extremely small footprint for close proximity to the data source

- MT38999/*MTP®/MPO/Glenair® Series 79 MT/VITA 66.X end options (Other options available. Contact Samtec.)
- Micro rugged board level connector system with positive latching, weld tabs and loading guides for secure connection
- An angled fiber exit from the housing to minimize keep-out zone on the board



Amphenol® MT38999





System

- ETUO Extended Temperature FireFly™ Optical Flyover™ Cable Assembly
- UEC5 Micro Edge Card Socket Assembly

technology

Multi-mode fiber

• UCC8 – Positive Latching Receptacle

For more information on Samtec's FireFly™ Micro Flyover System™, please visit www.samtec.com/firefly or contact Samtec Optical Group at firefly@samtec.com